



Welcome to [E-XFL.COM](http://E-XFL.COM)

#### Understanding Embedded - PLDs (Programmable Logic Devices)

Embedded - PLDs, or Programmable Logic Devices, are a type of digital electronic component used to build reconfigurable digital circuits. Unlike fixed-function logic devices, PLDs can be programmed to perform specific functions by the user. This flexibility allows designers to customize the logic to meet the exact needs of their applications, making PLDs a crucial component in modern embedded systems.

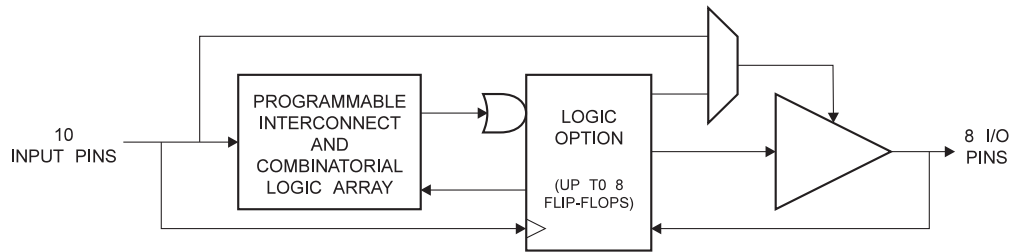
#### Applications of Embedded - PLDs (Programmable Logic Devices)

The versatility of PLDs makes them suitable for a wide range of applications. In consumer electronics, PLDs are used to enhance the functionality and performance of

#### Details

Product Status	Obsolete
Programmable Type	EE PLD
Number of Macrocells	8
Voltage - Input	5V
Speed	15 ns
Mounting Type	Surface Mount
Package / Case	20-LCC (J-Lead)
Supplier Device Package	20-PLCC (9x9)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/atf16v8cz-15ji">https://www.e-xfl.com/product-detail/microchip-technology/atf16v8cz-15ji</a>

Figure 1-1. Block Diagram



## 2. Pin Configuration and Pinouts

Table 2-1. Pinouts - All Pinouts Top View

Pin Name	Function
CLK	Clock
I	Logic Inputs
I/O	Bi-directional Buffers
$\overline{OE}$	Output Enable
VCC	+5V Supply

Figure 2-1. TSSOP

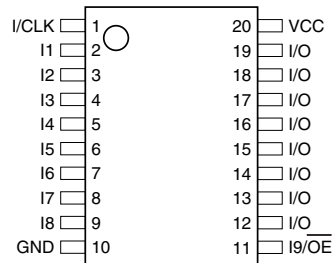


Figure 2-2. DIP/SOIC

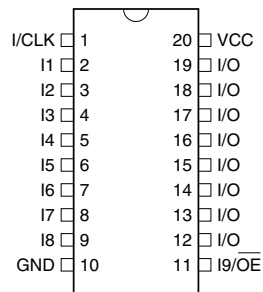
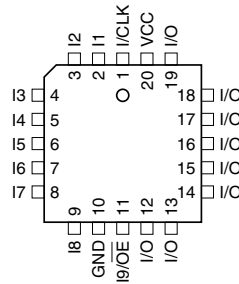


Figure 2-3. PLCC



### 3. Absolute Maximum Ratings\*

Temperature Under Bias.....	-40°C to +85°C
Storage Temperature .....	-65°C to +150°C
Voltage on Any Pin with Respect to Ground .....	-2.0V to +7.0V <sup>(1)</sup>
Voltage on Input Pins with Respect to Ground During Programming.....	-2.0V to +14.0V <sup>(1)</sup>
Programming Voltage with Respect to Ground .....	-2.0V to +14.0V <sup>(1)</sup>

**\*NOTICE:** Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**Note:** 1. Minimum voltage is -0.6V DC, which may undershoot to -2.0V for pulses of less than 20 ns. Maximum output pin voltage is  $V_{CC} + 0.75V$  DC, which may overshoot to 7.0V for pulses of less than 20 ns.

### 4. DC and AC Operating Conditions

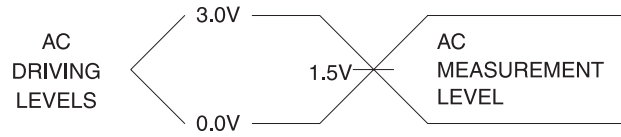
	Commercial	Industrial
Operating Temperature (Ambient)	0°C - 70°C	-40°C - 85°C
$V_{CC}$ Power Supply	5V ±5%	5V ±10%

#### 4.1 DC Characteristics

Symbol	Parameter	Condition	Min	Typ	Max	Units
$I_{IL}$	Input or I/O Low Leakage Current	$0 \leq V_{IN} \leq V_{IL}(\text{Max})$			-10	$\mu A$
$I_{IH}$	Input or I/O High Leakage Current	$3.5 \leq V_{IN} \leq V_{CC}$			10	$\mu A$
$I_{CC1}$	Power Supply Current	15 MHz, $V_{CC} = \text{Max}$ , $V_{IN} = 0$ , $V_{CC}$ , Outputs Open	Com		95	mA
			Ind.		105	mA
$I_{CC}^{(1)}$	Power Supply Current, Standby Mode	0 MHz, $V_{CC} = \text{Max}$ , $V_{IN} = 0$ , $V_{CC}$ , Outputs Open	Com.	5		$\mu A$
			Ind	5		$\mu A$
$I_{OS}$	Output Short Circuit Current	$V_{OUT} = 0.5V$ ; $V_{CC} = 5V$ ; $T_A = 25^\circ C$			-150	mA
$V_{IL}$	Input Low Voltage	$\text{Min} < V_{CC} < \text{Max}$	-0.5		0.8	V
$V_{IH}$	Input High Voltage		2.0		$V_{CC}+1$	V
$V_{OL}$	Output Low Voltage	$V_{CC} = \text{Min}$ , All Outputs $I_{OL} = -16 \text{ mA}$			0.5	V

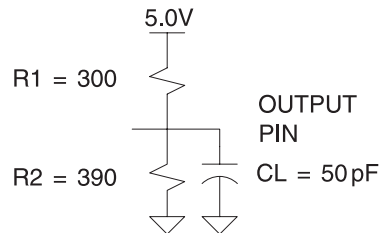
## 4.4 Input Test Waveforms

### 4.4.1 Input Test Waveforms and Measurement Levels



$$t_R, t_F < 1.5 \text{ ns (10% to 90%)}$$

### 4.4.2 Output Test Loads



Note: Similar devices are tested with slightly different loads. These load differences may affect output signals' delay and slew rate. Atmel devices are tested with sufficient margins to meet compatible devices.

### 4.4.3 Pin Capacitance

**Table 4-1.** Pin Capacitance ( $f = 1 \text{ MHz}$ ,  $T = 25^\circ\text{C}^{(1)}$ )

	Typ	Max	Units	Conditions
$C_{IN}$	5	8	pF	$V_{IN} = 0V$
$C_{OUT}$	6	8	pF	$V_{OUT} = 0V$

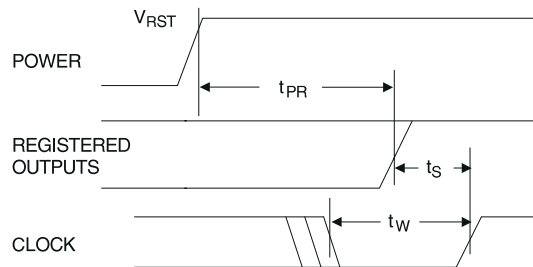
Note: 1. Typical values for nominal supply voltage. This parameter is only sampled and is not 100% tested.

## 4.5 Power-up Reset

The ATF16V8CZ's registers are designed to reset during power-up. At a point delayed slightly from  $V_{CC}$  crossing  $V_{RST}$ , all registers will be reset to the low state. As a result, the registered output state will always be high on power-up.

This feature is critical for state machine initialization. However, due to the asynchronous nature of reset and the uncertainty of how  $V_{CC}$  actually rises in the system, the following conditions are required:

1. The  $V_{CC}$  rise must be monotonic, from below 0.7V,
2. After reset occurs, all input and feedback setup times must be met before driving the clock term high, and
3. The signals from which the clock is derived must remain stable during  $t_{PR}$ .



Parameter	Description	Typ	Max	Units
$t_{PR}$	Power-up Reset Time	600	1,000	ns
$V_{RST}$	Power-up Reset Voltage	3.8	4.5	V

## 4.6 Preload of Registered Outputs

The ATF16V8CZ's registers are provided with circuitry to allow loading of each register with either a high or a low. This feature will simplify testing since any state can be forced into the registers to control test sequencing. A JEDEC file with preload is generated when a source file with vectors is compiled. Once downloaded, the JEDEC file preload sequence will be done automatically by approved programmers.

## 5. Security Fuse Usage

A single fuse is provided to prevent unauthorized copying of the ATF16V8CZ fuse patterns. Once programmed, fuse verify and preload are inhibited. However, the 64-bit User Signature remains accessible.

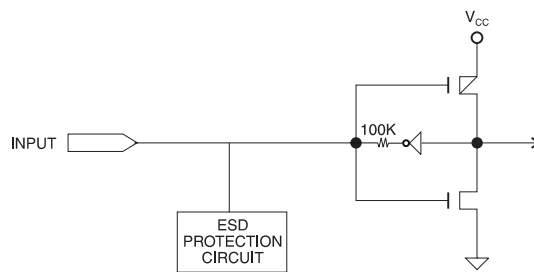
The security fuse should be programmed last, as its effect is immediate.

## 6. Input and I/O Pin-keeper Circuits

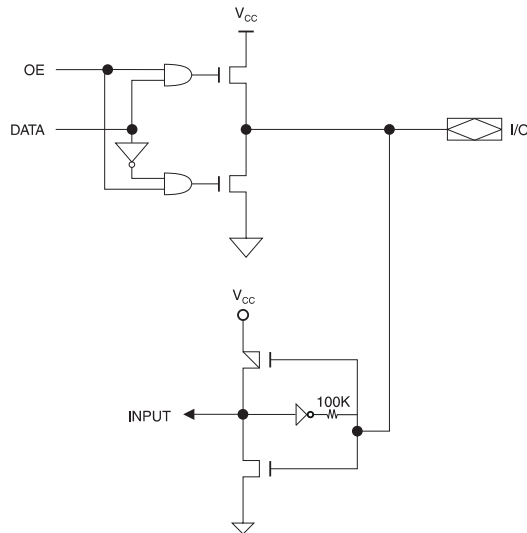
The ATF16V8CZ contains internal input and I/O pin-keeper circuits. These circuits allow each ATF16V8CZ pin to hold its previous value even when it is not being driven by an external source or by the device's output buffer. This helps insure that all logic array inputs are at known, valid logic levels. This reduces system power by preventing pins from floating to indeterminate levels. By using pin-keeper circuits rather than pull-up resistors, there is no DC current required to hold the pins in either logic state (high or low).

These pin-keeper circuits are implemented as weak feedback inverters, as shown in the Input Diagram below. These keeper circuits can easily be overdriven by standard TTL- or CMOS-compatible drivers. The typical overdrive current required is 40  $\mu\text{A}$ .

**Figure 6-1.** Input Diagram



**Figure 6-2.** I/O Diagram



## 8. Macrocell Configuration

Software compilers support the three different OMC modes as different device types. These device types are listed in the table below. Most compilers have the ability to automatically select the device type, generally based on the register usage and output enable ( $\overline{OE}$ ) usage. Register usage on the device forces the software to choose the registered mode. All combinatorial outputs with  $\overline{OE}$  controlled by the product term will force the software to choose the complex mode. The software will choose the simple mode only when all outputs are dedicated combinatorial without  $\overline{OE}$  control. The different device types listed in the table can be used to override the automatic device selection by the software. For further details, refer to the compiler software manuals.

When using compiler software to configure the device, the user must pay special attention to the following restrictions in each mode.

In **registered mode** pin 1 and pin 11 are permanently configured as clock and output enable, respectively. These pins cannot be configured as dedicated inputs in the registered mode.

In **complex mode** pin 1 and pin 11 become dedicated inputs and use the feedback paths of pin 19 and pin 12 respectively. Because of this feedback path usage, pin 19 and pin 12 do not have the feedback option in this mode.

In **simple mode** all feedback paths of the output pins are routed via the adjacent pins. In doing so, the two inner most pins (pins 15 and 16) will not have the feedback option as these pins are always configured as dedicated combinatorial output.

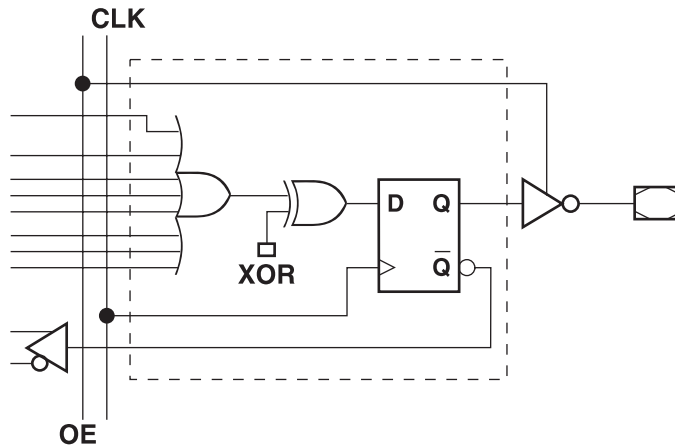
### 8.1 ATF16V8CZ Registered Mode

**PAL Device Emulation/PAL Replacement.** The registered mode is used if one or more registers are required. Each macrocell can be configured as either a registered or combinatorial output or I/O, or as an input. For a registered output or I/O, the output is enabled by the  $\overline{OE}$  pin, and the register is clocked by the CLK pin. Eight product terms are allocated to the sum term. For a combinatorial output or I/O, the output enable is controlled by a product term, and seven product terms are allocated to the sum term. When the macrocell is configured as an input, the output enable is permanently disabled.

Any register usage will make the compiler select this mode. The following registered devices can be emulated using this mode:

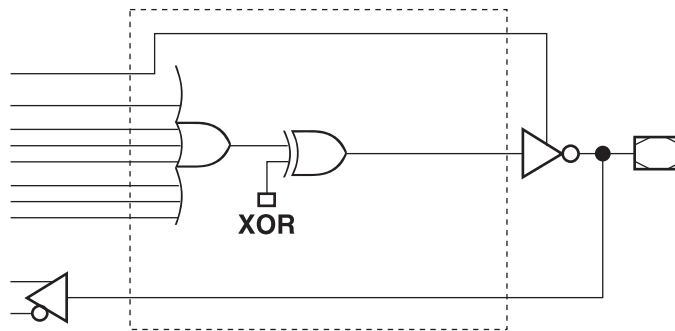
16R8	16RP8
16R6	16RP6
16R4	16RP4

**Figure 8-1.** Registered Configuration for Registered Mode<sup>(1)(2)</sup>



- Notes:
1. Pin 1 controls common CLK for the registered outputs.  
Pin 11 controls common  $\overline{OE}$  for the registered outputs.  
Pin 1 and Pin 11 are permanently configured as CLK and  $\overline{OE}$ .
  2. The development software configures all the architecture control bits and checks for proper pin usage automatically.

**Figure 8-2.** Combinatorial Configuration for Registered Mode<sup>(1)(2)</sup>



- Notes:
1. Pin 1 and Pin 11 are permanently configured as CLK and  $\overline{OE}$ .
  2. The development software configures all the architecture control bits and checks for proper pin usage automatically.



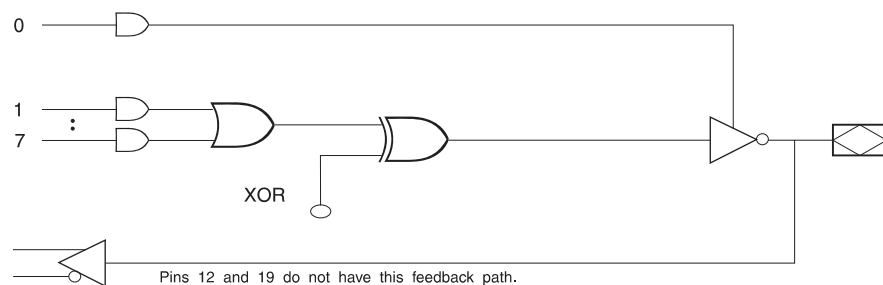
## 8.2 ATF16V8CZ Complex Mode

**PAL Device Emulation/PAL Replacement.** In the complex mode, combinatorial output and I/O functions are possible. Pins 1 and 11 are regular inputs to the array. Pins 13 through 18 have pin feedback paths back to the AND-array, which makes full I/O capability possible. Pins 12 and 19 (outermost macrocells) are outputs only. They do not have input capability. In this mode, each macrocell has seven product terms going to the sum term and one product term enabling the output.

Combinatorial applications with an  $\overline{OE}$  requirement will make the compiler select this mode. The following devices can be emulated using this mode:

- 16L8
- 16H8
- 16P8

**Figure 8-4.** Complex Mode Option



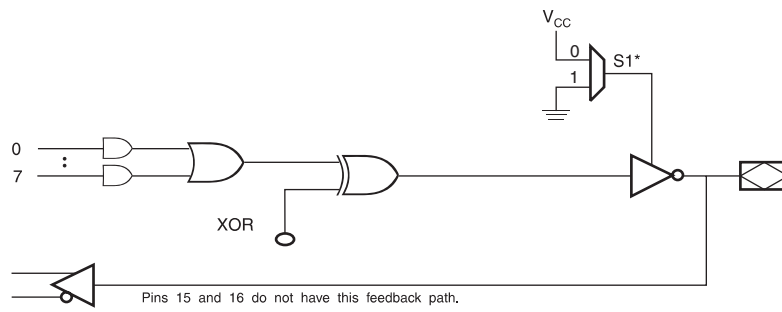
## 9. ATF16V8CZ Simple Mode

**PAL Device Emulation/PAL Replacement.** In the Simple Mode, 8 product terms are allocated to the sum term. Pins 15 and 16 (center macrocells) are permanently configured as combinatorial outputs. Other macrocells can be either inputs or combinatorial outputs with pin feedback to the AND-array. Pins 1 and 11 are regular inputs.

The compiler selects this mode when all outputs are combinatorial without  $\overline{OE}$  control. The following simple PALs can be emulated using this mode:

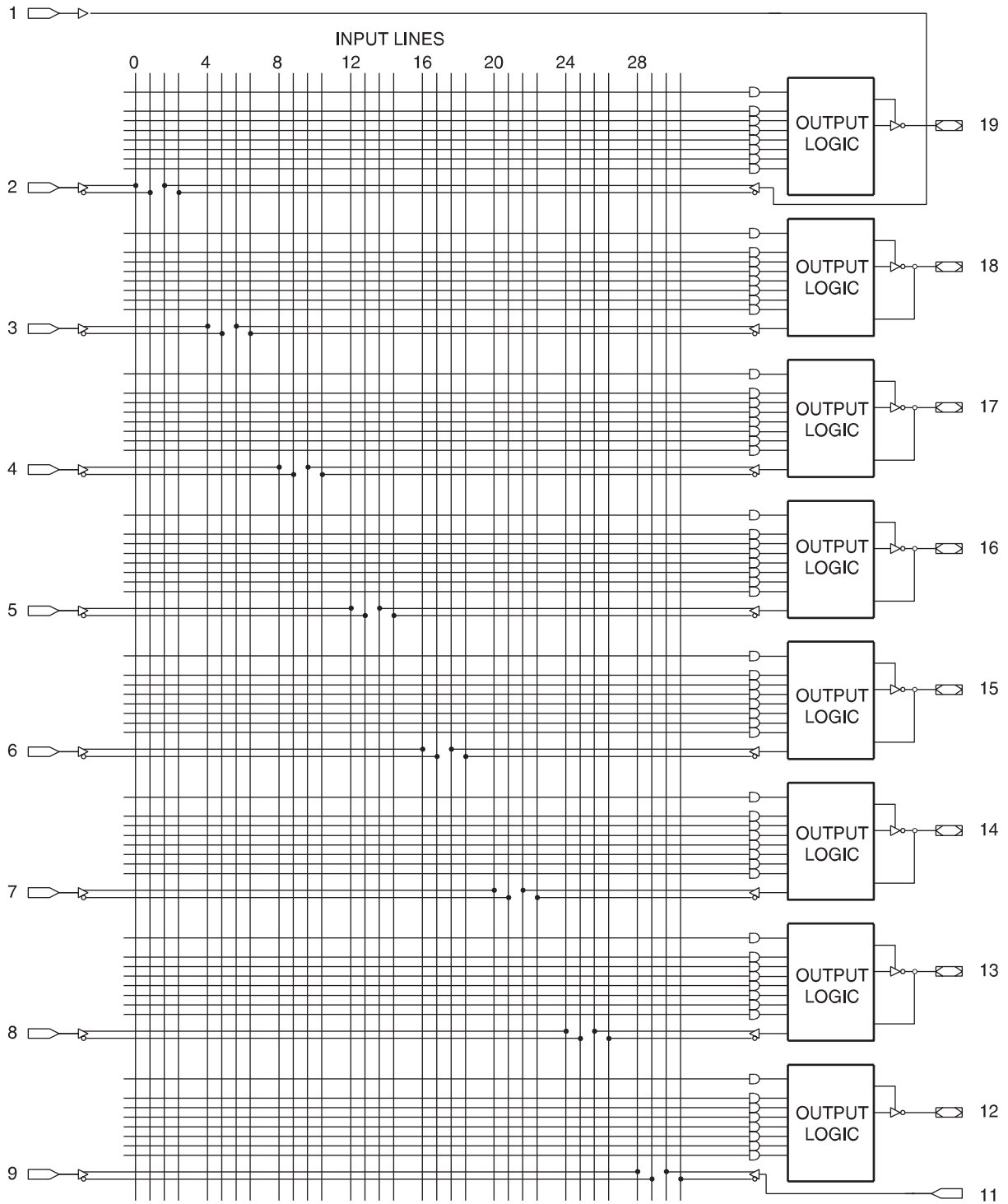
- 10L8 10H8 10P8
- 12L6 12H6 12P6
- 14L4 14H4 14P4
- 16L2 16H2 16P2

**Figure 9-1.** Simple Mode Option

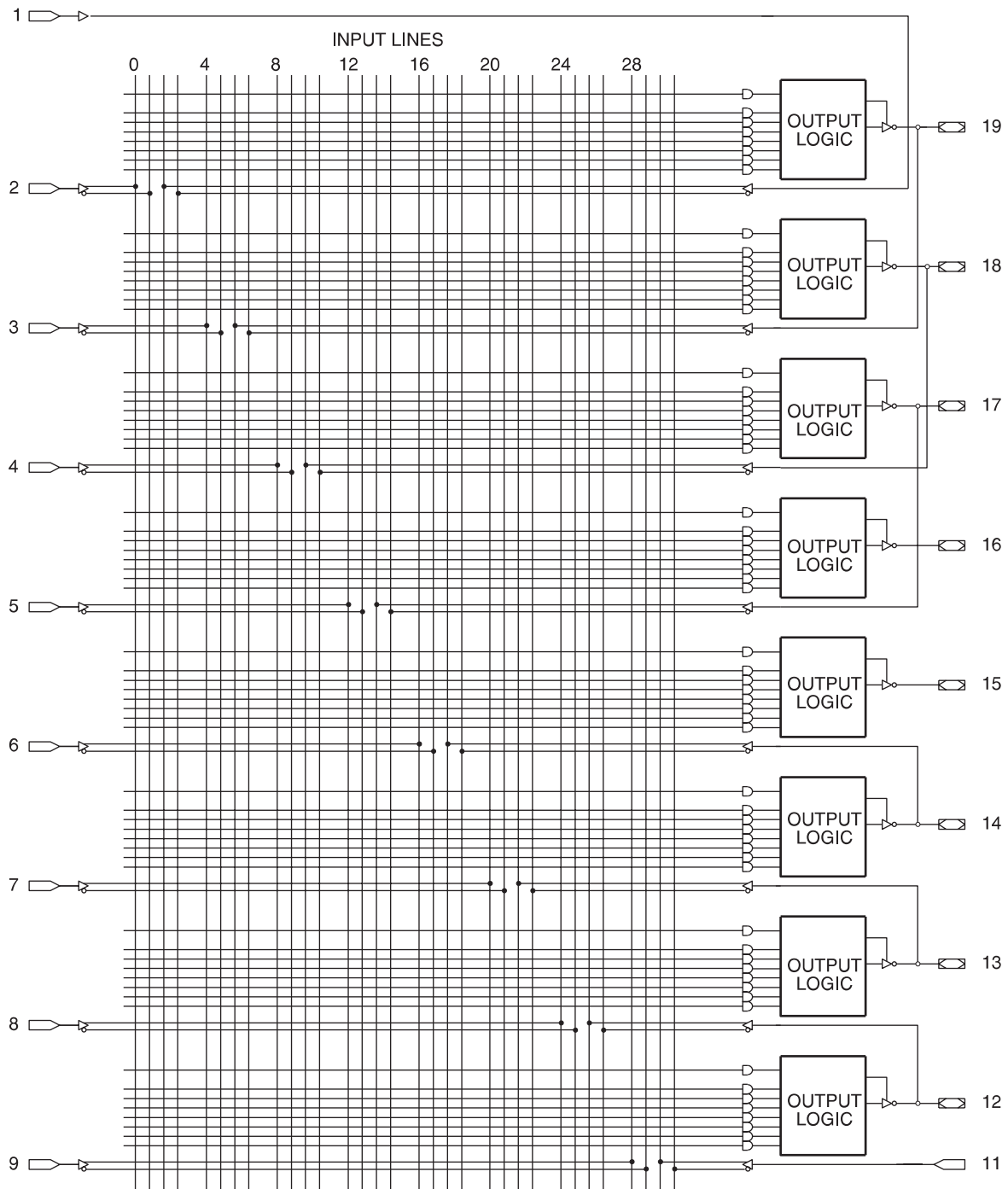


\* - Pins 15 and 16 are always enabled.

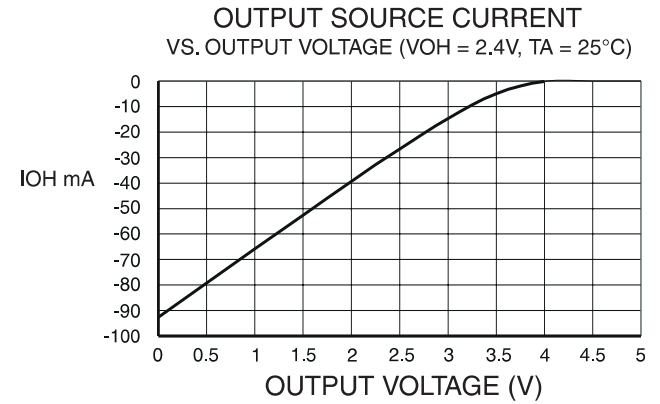
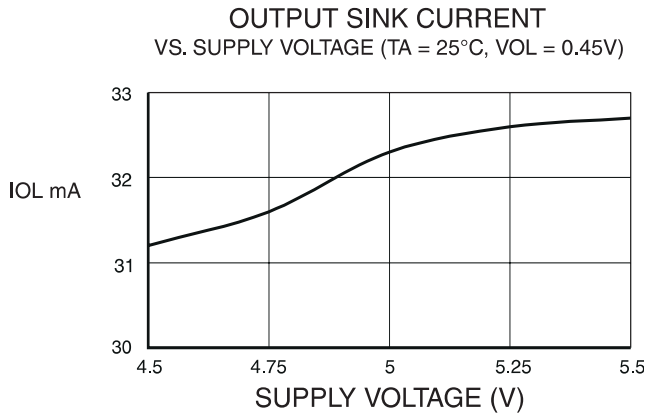
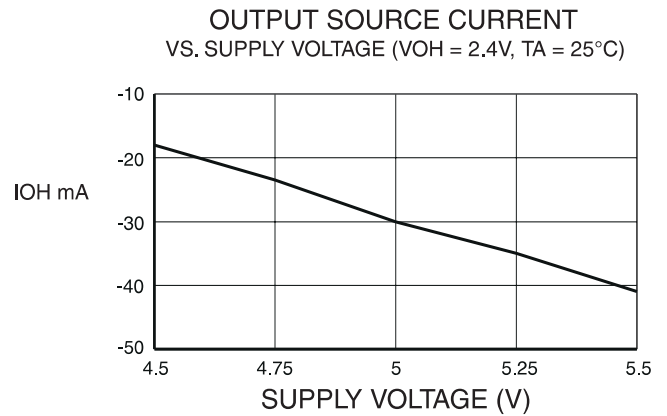
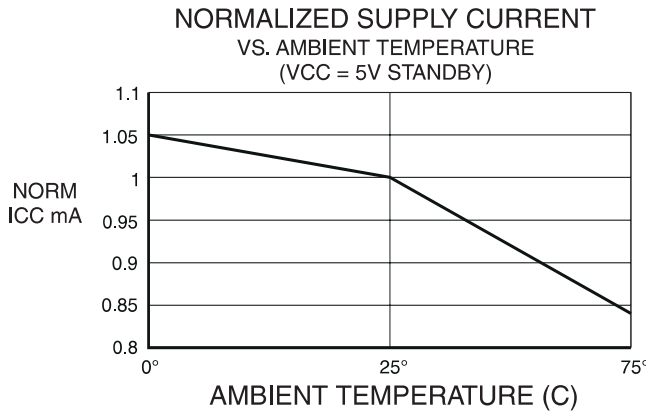
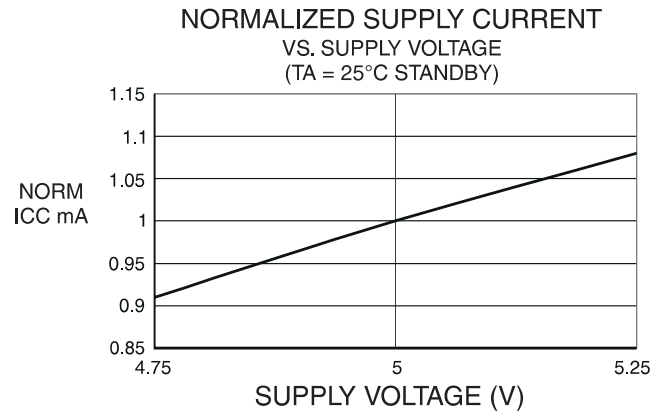
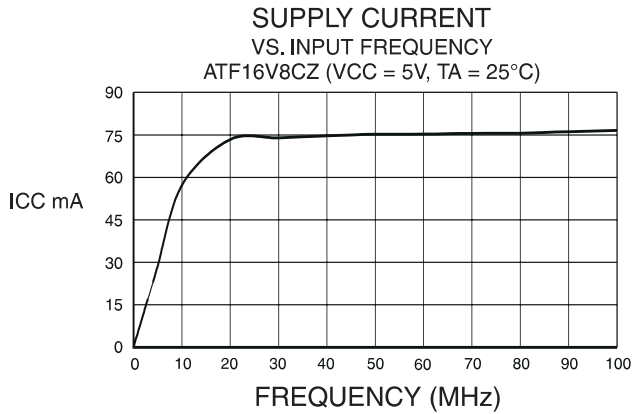
Figure 9-2. Complex Mode Logic Diagram



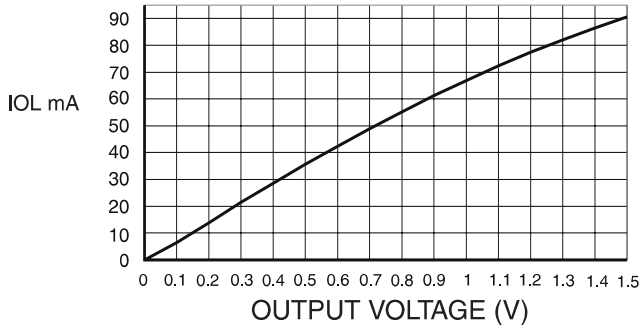
**Figure 9-3.** Simple Mode Logic Diagram



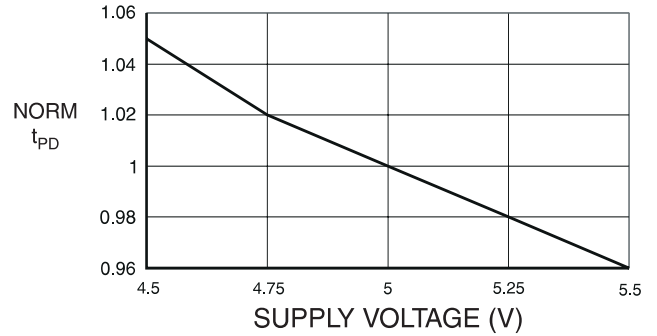
## 9.1 Test Characterization Data



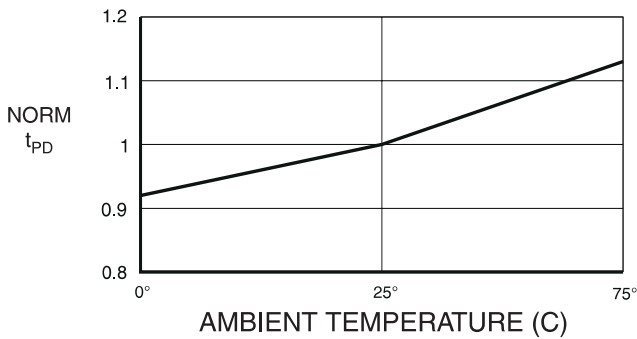
OUTPUT SINK CURRENT  
VS. OUTPUT VOLTAGE (VCC = 5V, TA = 25°C)



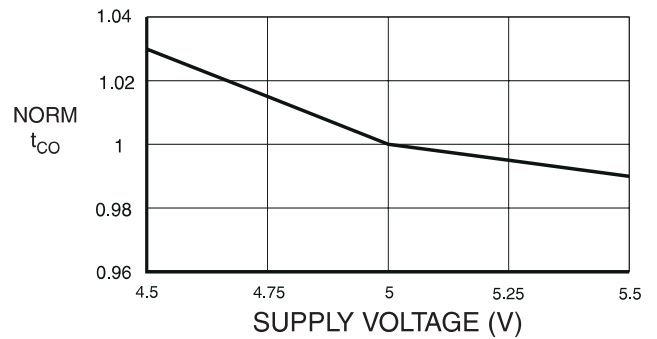
NORMALIZED  $t_{PD}$   
VS. SUPPLY VOLTAGE (TA = 25°C)



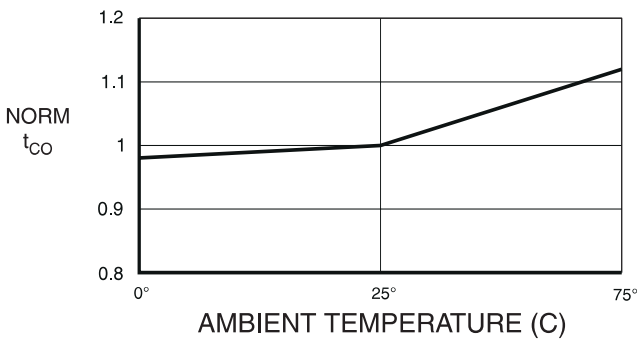
NORMALIZED  $t_{PD}$   
VS. AMBIENT TEMPERATURE (TA = 25°C)



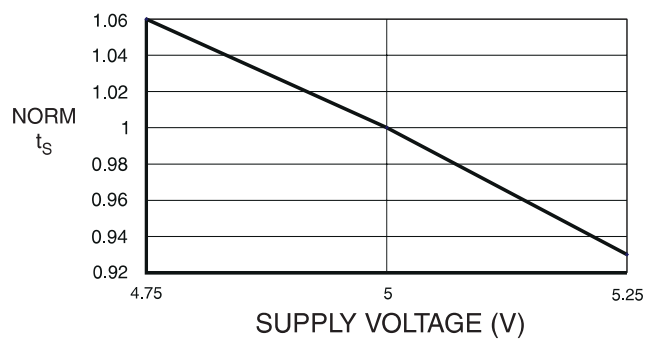
NORMALIZED  $t_{CO}$   
VS. SUPPLY VOLTAGE (TA = 25°C)

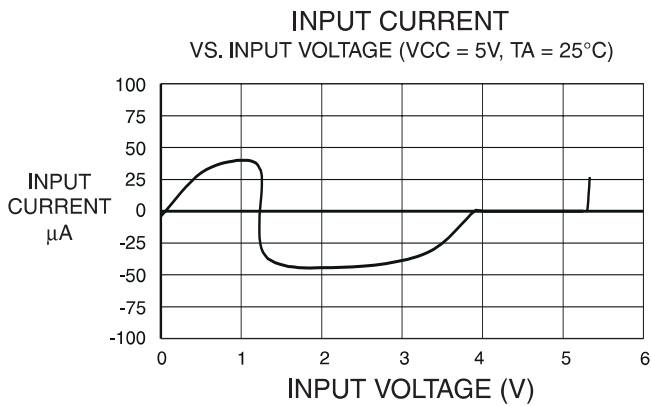
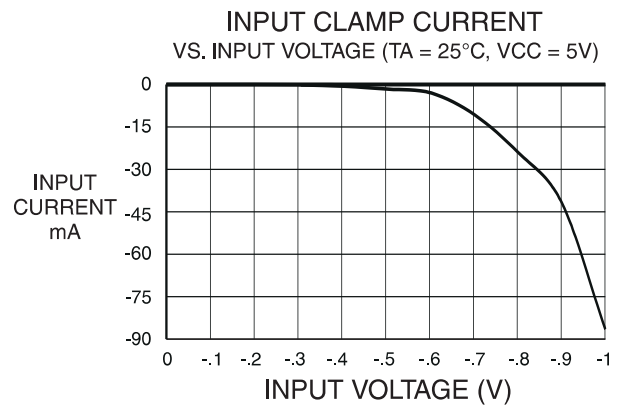
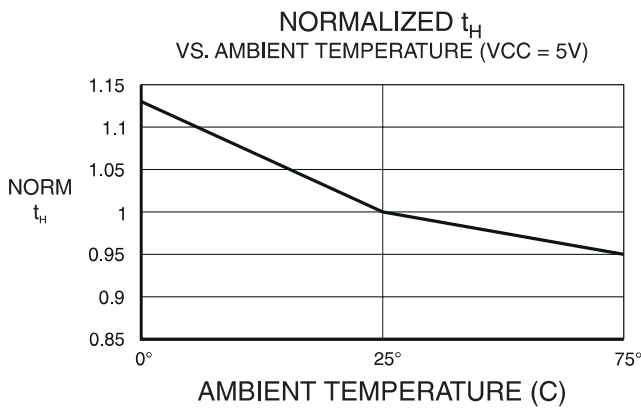
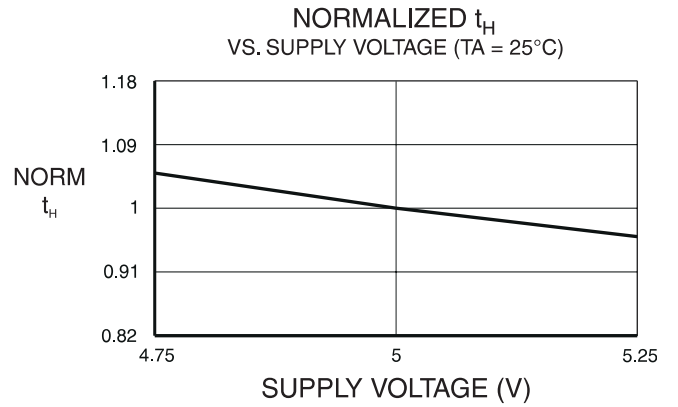
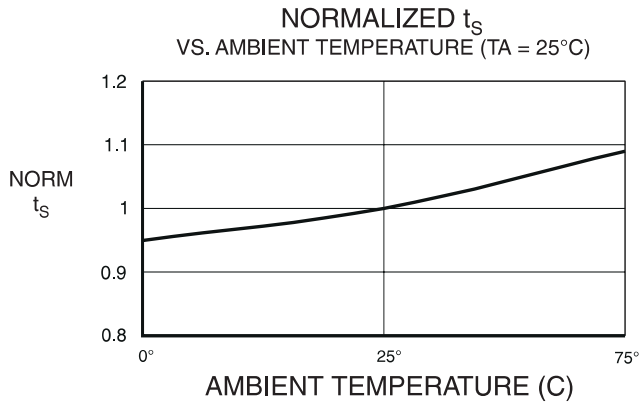


NORMALIZED  $t_{CO}$   
VS. AMBIENT TEMPERATURE (VCC = 5V)



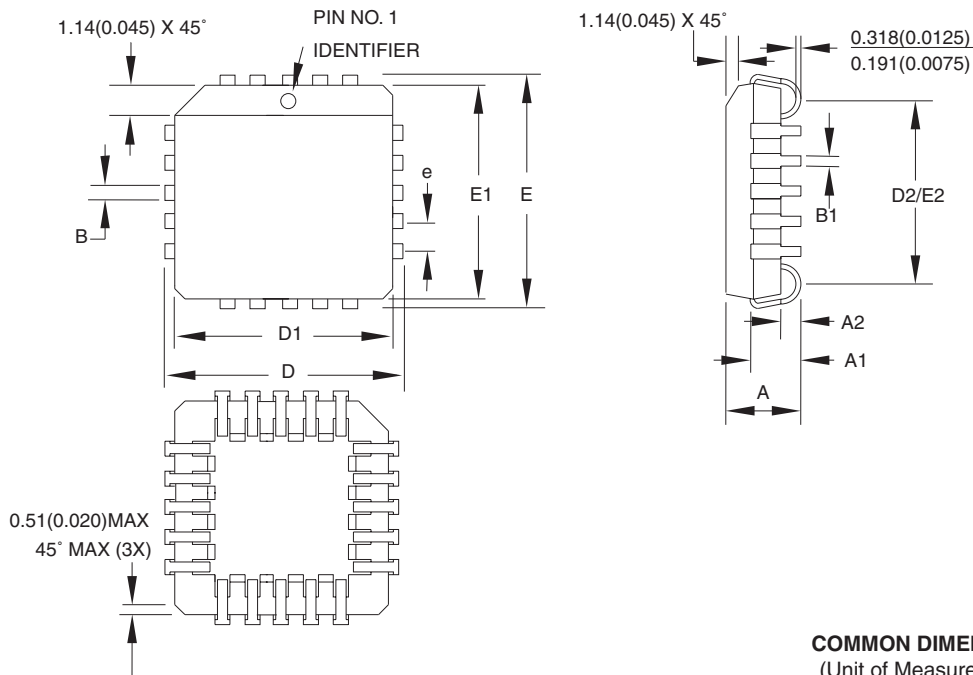
NORMALIZED  $t_S$   
VS. SUPPLY VOLTAGE (TA = 25°C)





11. Package Information

11.1 20J – PLCC



**COMMON DIMENSIONS**  
(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A	4.191	-	4.572	
A1	2.286	-	3.048	
A2	0.508	-	-	
D	9.779	-	10.033	
D1	8.890	-	9.042	Note 2
E	9.779	-	10.033	
E1	8.890	-	9.042	Note 2
D2/E2	7.366	-	8.382	
B	0.660	-	0.813	
B1	0.330	-	0.533	
e	1.270 TYP			

- Notes:
1. This package conforms to JEDEC reference MS-018, Variation AA.
  2. Dimensions D1 and E1 do not include mold protrusion. Allowable protrusion is .010"(0.254 mm) per side. Dimension D1 and E1 include mold mismatch and are measured at the extreme material condition at the upper or lower parting line.
  3. Lead coplanarity is 0.004" (0.102 mm) maximum.

10/04/01



2325 Orchard Parkway  
San Jose, CA 95131

**TITLE**

20J, 20-lead, Plastic J-leaded Chip Carrier (PLCC)

**DRAWING NO.**

20J

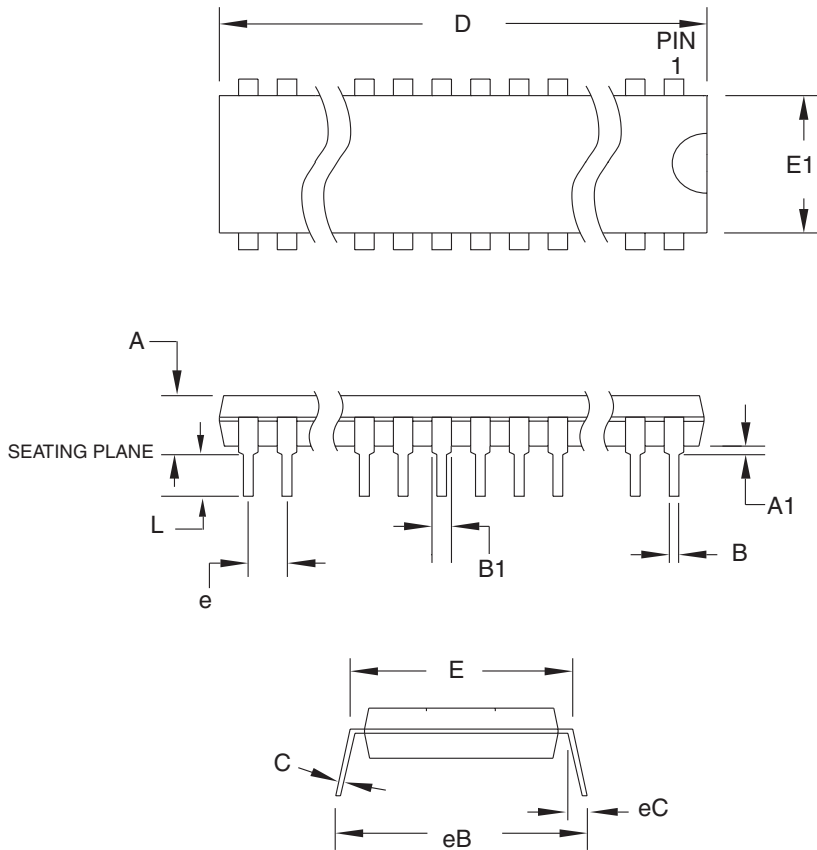
**REV.**

B





## 11.2 20P3 – PDIP



**COMMON DIMENSIONS**  
(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A	–	–	5.334	
A1	0.381	–	–	
D	24.892	–	26.924	Note 2
E	7.620	–	8.255	
E1	6.096	–	7.112	Note 2
B	0.356	–	0.559	
B1	1.270	–	1.551	
L	2.921	–	3.810	
C	0.203	–	0.356	
eB	–	–	10.922	
eC	0.000	–	1.524	
e	2.540 TYP			

- Notes:
1. This package conforms to JEDEC reference MS-001, Variation AD.
  2. Dimensions D and E1 do not include mold Flash or Protrusion. Mold Flash or Protrusion shall not exceed 0.25 mm (0.010").

1/23/04



2325 Orchard Parkway  
San Jose, CA 95131

**TITLE**

**20P3**, 20-lead (0.300"/7.62 mm Wide) Plastic Dual  
Inline Package (PDIP)

**DRAWING NO.**

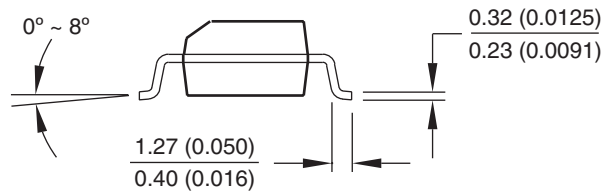
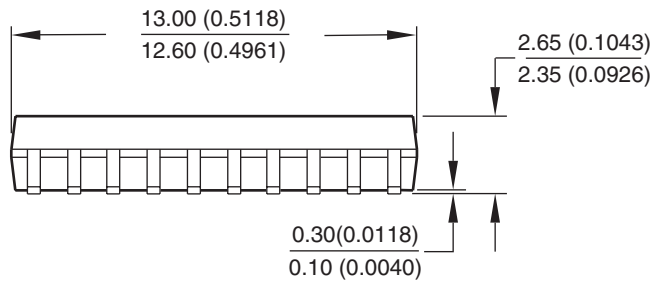
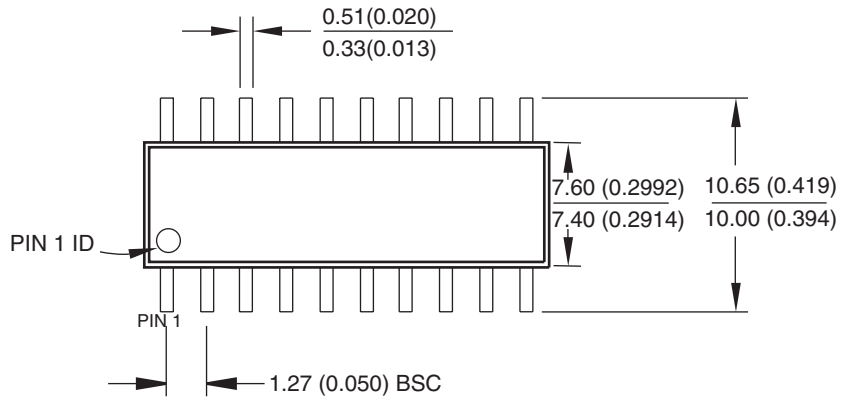
20P3

**REV.**

D

11.3 20S – SOIC

Dimensions in Millimeters and (Inches).  
 Controlling dimension: Inches.  
 JEDEC Standard MS-013



10/23/03



2325 Orchard Parkway  
 San Jose, CA 95131

**TITLE**

**20S**, 20-lead, 0.300" Body, Plastic Gull Wing Small Outline (SOIC)

**DRAWING NO.**

20S

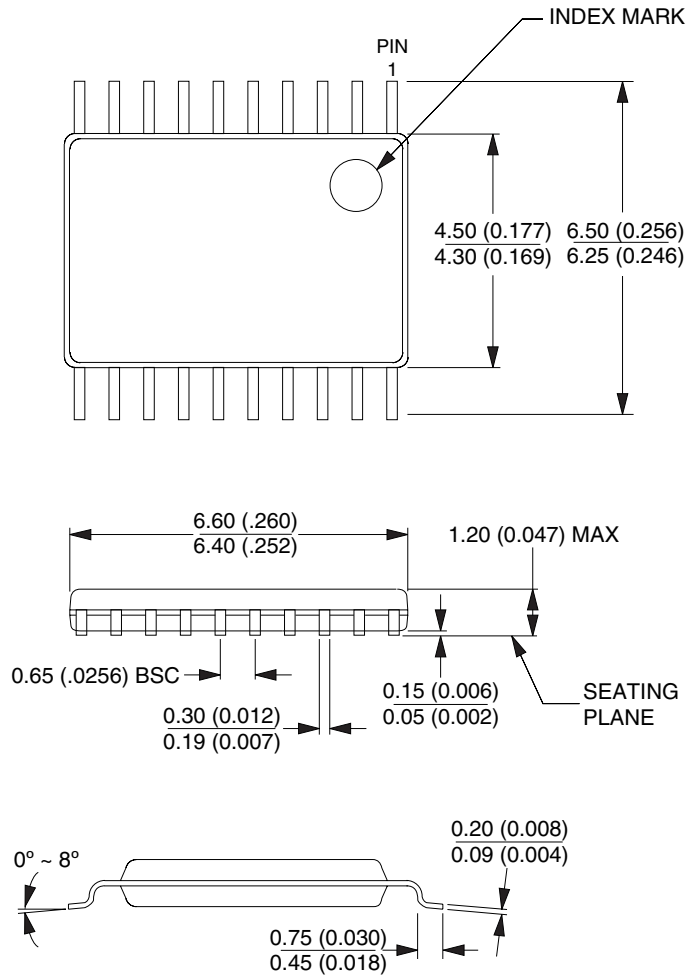
**REV.**

B



### 11.4 20X – TSSOP

Dimensions in Millimeters and (Inches).  
 Controlling dimension: Millimeters.  
 JEDEC Standard MO-153 AC



10/23/03



2325 Orchard Parkway  
 San Jose, CA 95131

**TITLE**

**20X**, (Formerly 20T), 20-lead, 4.4 mm Body Width,  
 Plastic Thin Shrink Small Outline Package (TSSOP)

**DRAWING NO.**

20X

**REV.**

C

## 12. Revision History

### 12.1 0453H

1. Green Package options added in 2005.



## Atmel Corporation

2325 Orchard Parkway  
San Jose, CA 95131, USA  
Tel: 1(408) 441-0311  
Fax: 1(408) 487-2600

## Regional Headquarters

### Europe

Atmel Sarl  
Route des Arsenalux 41  
Case Postale 80  
CH-1705 Fribourg  
Switzerland  
Tel: (41) 26-426-5555  
Fax: (41) 26-426-5500

### Asia

Room 1219  
Chinachem Golden Plaza  
77 Mody Road Tsimshatsui  
East Kowloon  
Hong Kong  
Tel: (852) 2721-9778  
Fax: (852) 2722-1369

### Japan

9F, Tonetsu Shinkawa Bldg.  
1-24-8 Shinkawa  
Chuo-ku, Tokyo 104-0033  
Japan  
Tel: (81) 3-3523-3551  
Fax: (81) 3-3523-7581

## Atmel Operations

### Memory

2325 Orchard Parkway  
San Jose, CA 95131, USA  
Tel: 1(408) 441-0311  
Fax: 1(408) 436-4314

### Microcontrollers

2325 Orchard Parkway  
San Jose, CA 95131, USA  
Tel: 1(408) 441-0311  
Fax: 1(408) 436-4314

La Chantrerie  
BP 70602  
44306 Nantes Cedex 3, France  
Tel: (33) 2-40-18-18-18  
Fax: (33) 2-40-18-19-60

### ASIC/ASSP/Smart Cards

Zone Industrielle  
13106 Rousset Cedex, France  
Tel: (33) 4-42-53-60-00  
Fax: (33) 4-42-53-60-01

1150 East Cheyenne Mtn. Blvd.  
Colorado Springs, CO 80906, USA  
Tel: 1(719) 576-3300  
Fax: 1(719) 540-1759

Scottish Enterprise Technology Park  
Maxwell Building  
East Kilbride G75 0QR, Scotland  
Tel: (44) 1355-803-000  
Fax: (44) 1355-242-743

### RF/Automotive

Theresienstrasse 2  
Postfach 3535  
74025 Heilbronn, Germany  
Tel: (49) 71-31-67-0  
Fax: (49) 71-31-67-2340

1150 East Cheyenne Mtn. Blvd.  
Colorado Springs, CO 80906, USA  
Tel: 1(719) 576-3300  
Fax: 1(719) 540-1759

### Biometrics/Imaging/Hi-Rel MPU/ High Speed Converters/RF Datacom

Avenue de Rochepleine  
BP 123  
38521 Saint-Egreve Cedex, France  
Tel: (33) 4-76-58-30-00  
Fax: (33) 4-76-58-34-80

---

## Literature Requests

[www.atmel.com/literature](http://www.atmel.com/literature)

**Disclaimer:** The information in this document is provided in connection with Atmel products. No license, express or implied, by estoppel or otherwise, to any intellectual property right is granted by this document or in connection with the sale of Atmel products. **EXCEPT AS SET FORTH IN ATMEL'S TERMS AND CONDITIONS OF SALE LOCATED ON ATMEL'S WEB SITE, ATMEL ASSUMES NO LIABILITY WHATSOEVER AND DISCLAIMS ANY EXPRESS, IMPLIED OR STATUTORY WARRANTY RELATING TO ITS PRODUCTS INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTY OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, OR NON-INFRINGEMENT. IN NO EVENT SHALL ATMEL BE LIABLE FOR ANY DIRECT, INDIRECT, CONSEQUENTIAL, PUNITIVE, SPECIAL OR INCIDENTAL DAMAGES (INCLUDING, WITHOUT LIMITATION, DAMAGES FOR LOSS OF PROFITS, BUSINESS INTERRUPTION, OR LOSS OF INFORMATION) ARISING OUT OF THE USE OR INABILITY TO USE THIS DOCUMENT, EVEN IF ATMEL HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES.** Atmel makes no representations or warranties with respect to the accuracy or completeness of the contents of this document and reserves the right to make changes to specifications and product descriptions at any time without notice. Atmel does not make any commitment to update the information contained herein. Unless specifically provided otherwise, Atmel products are not suitable for, and shall not be used in, automotive applications. Atmel's products are not intended, authorized, or warranted for use as components in applications intended to support or sustain life.

© Atmel Corporation 2005. All rights reserved. Atmel®, logo and combinations thereof, Everywhere You Are® and others, are registered trademarks or trademarks of Atmel Corporation or its subsidiaries. Other terms and product names may be trademarks of others.



Printed on recycled paper.

0453H-PLD-7/05